

# BAT54SLT1

Preferred Device

## Dual Series Schottky Barrier Diodes

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

- Extremely Fast Switching Speed
- Low Forward Voltage – 0.35 V (Typ) @  $I_F = 10$  mAdc
- Pb-Free Package May be Available. The G-Suffix Denotes a Pb-Free Lead Finish

### MAXIMUM RATINGS ( $T_J = 125^\circ\text{C}$ unless otherwise noted)

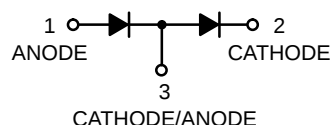
| Rating                                                                                     | Symbol    | Value       | Unit                       |
|--------------------------------------------------------------------------------------------|-----------|-------------|----------------------------|
| Reverse Voltage                                                                            | $V_R$     | 30          | Volts                      |
| Forward Power Dissipation<br>@ $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_F$     | 225<br>1.8  | mW<br>mW/ $^\circ\text{C}$ |
| Forward Current (DC)                                                                       | $I_F$     | 200 Max     | mA                         |
| Junction Temperature                                                                       | $T_J$     | 125 Max     | $^\circ\text{C}$           |
| Storage Temperature Range                                                                  | $T_{stg}$ | -55 to +150 | $^\circ\text{C}$           |



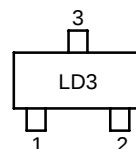
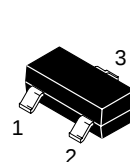
ON Semiconductor®

<http://onsemi.com>

### 30 VOLT DUAL HOT-CARRIER DETECTOR AND SWITCHING DIODES



### MARKING DIAGRAM



(TO-236AB)  
SOT-23  
CASE 318  
Style 11

### ORDERING INFORMATION

| Device     | Package             | Shipping†        |
|------------|---------------------|------------------|
| BAT54SLT1  | SOT-23              | 3000/Tape & Reel |
| BAT54SLT1G | SOT-23<br>(Pb-Free) | 3000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

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## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) (EACH DIODE)

| Characteristic                                                                                         | Symbol      | Min | Typ  | Max  | Unit            |
|--------------------------------------------------------------------------------------------------------|-------------|-----|------|------|-----------------|
| Reverse Breakdown Voltage ( $I_R = 10\ \mu\text{A}$ )                                                  | $V_{(BR)R}$ | 30  | –    | –    | Volts           |
| Total Capacitance ( $V_R = 1.0\ \text{V}$ , $f = 1.0\ \text{MHz}$ )                                    | $C_T$       | –   | 7.6  | 10   | pF              |
| Reverse Leakage ( $V_R = 25\ \text{V}$ )                                                               | $I_R$       | –   | 0.5  | 2.0  | $\mu\text{Adc}$ |
| Forward Voltage ( $I_F = 0.1\ \text{mAdc}$ )                                                           | $V_F$       | –   | 0.22 | 0.24 | Vdc             |
| Forward Voltage ( $I_F = 30\ \text{mAdc}$ )                                                            | $V_F$       | –   | 0.41 | 0.5  | Vdc             |
| Forward Voltage ( $I_F = 100\ \text{mAdc}$ )                                                           | $V_F$       | –   | 0.52 | 0.8  | Vdc             |
| Reverse Recovery Time<br>( $I_F = I_R = 10\ \text{mAdc}$ , $I_{R(REC)} = 1.0\ \text{mAdc}$ , Figure 1) | $t_{rr}$    | –   | –    | 5.0  | ns              |
| Forward Voltage ( $I_F = 1.0\ \text{mAdc}$ )                                                           | $V_F$       | –   | 0.29 | 0.32 | Vdc             |
| Forward Voltage ( $I_F = 10\ \text{mAdc}$ )                                                            | $V_F$       | –   | 0.35 | 0.40 | Vdc             |
| Forward Current (DC)                                                                                   | $I_F$       | –   | –    | 200  | mAdc            |
| Repetitive Peak Forward Current                                                                        | $I_{FRM}$   | –   | –    | 300  | mAdc            |
| Non-Repetitive Peak Forward Current ( $t < 1.0\ \text{s}$ )                                            | $I_{FSM}$   | –   | –    | 600  | mAdc            |

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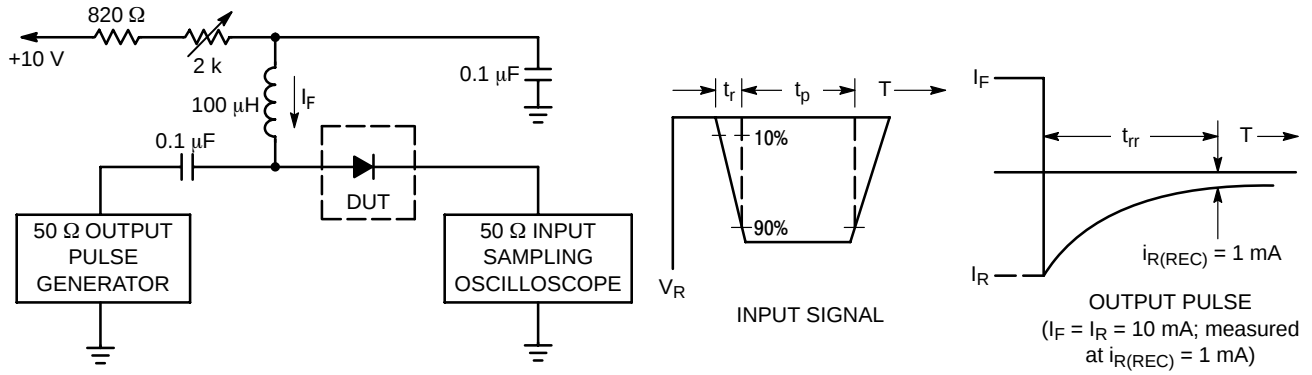


Figure 1. Recovery Time Equivalent Test Circuit

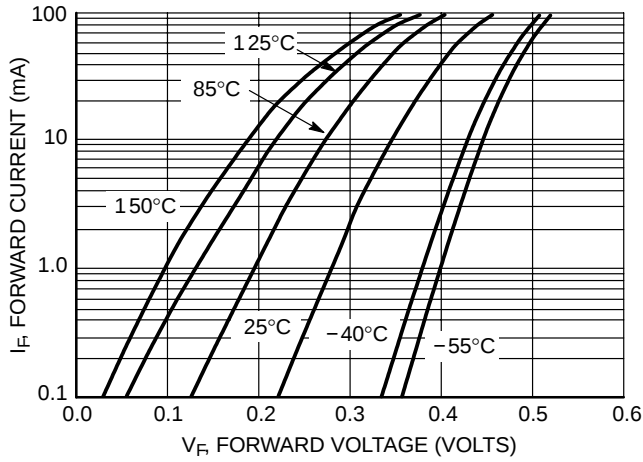


Figure 2. Forward Voltage

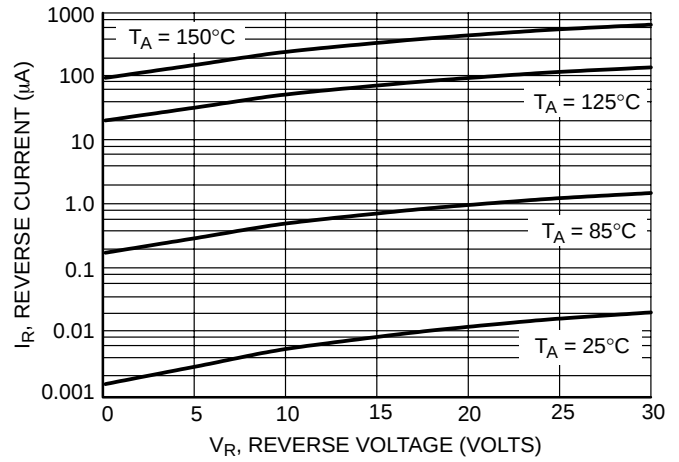


Figure 3. Leakage Current

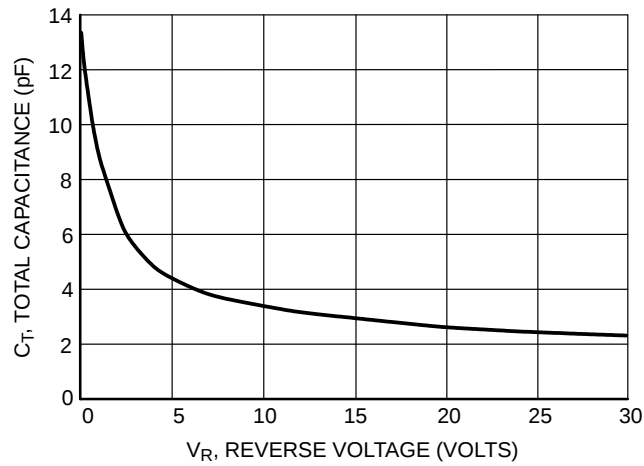
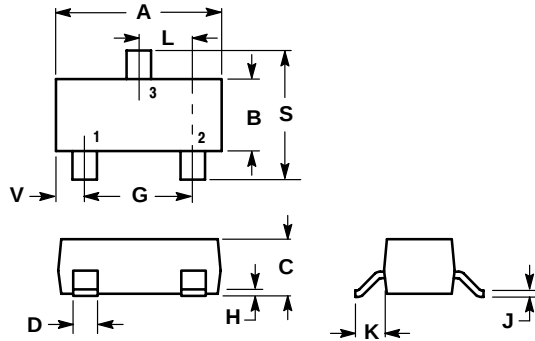


Figure 4. Total Capacitance

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## PACKAGE DIMENSIONS

### SOT-23 (TO-236) CASE 318-08 ISSUE AH



#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-03 AND -07 OBSOLETE, NEW STANDARD 318-08.

| DIM | INCHES |        | MILLIMETERS |       |
|-----|--------|--------|-------------|-------|
|     | MIN    | MAX    | MIN         | MAX   |
| A   | 0.1102 | 0.1197 | 2.80        | 3.04  |
| B   | 0.0472 | 0.0551 | 1.20        | 1.40  |
| C   | 0.0350 | 0.0440 | 0.89        | 1.11  |
| D   | 0.0150 | 0.0200 | 0.37        | 0.50  |
| G   | 0.0701 | 0.0807 | 1.78        | 2.04  |
| H   | 0.0005 | 0.0040 | 0.013       | 0.100 |
| J   | 0.0034 | 0.0070 | 0.085       | 0.177 |
| K   | 0.0140 | 0.0285 | 0.35        | 0.69  |
| L   | 0.0350 | 0.0401 | 0.89        | 1.02  |
| S   | 0.0830 | 0.1039 | 2.10        | 2.64  |
| V   | 0.0177 | 0.0236 | 0.45        | 0.60  |

#### STYLE 11:

- PIN 1. ANODE
- CATHODE
- CATHODE-ANODE

### SOLDERING FOOTPRINT\*

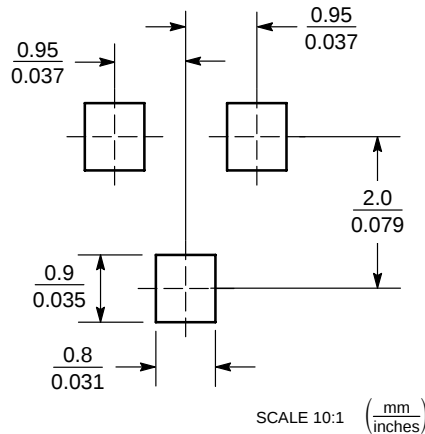


Figure 5. SOT-23

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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